CLAIMS

1. A phenolic resin molding compound comprising:

(A) a novolac phenolic resin with an o/p ratio (ortho/para ratio) of 0.7 to 0.9;

(B) a novolac phenolic resin with an o/p ratio of 1.1 to 1.3;

(C) talc; and

(D) a polyethylene or polyethylene/polypropylene copolymer, wherein

an amount of (D) the polyethylene or polyethylene/polypropylene copolymer relative to a total weight of the phenolic resin molding compound is 0.5 to 1.5 weight %.

2. The phenolic resin molding compound according to Claim 1, wherein a total amount of (A) and (B) relative to the total amount of the phenolic resin molding compound is 20 to 40 weight %, and an amount of (C) relative to the total amount of the phenolic resin molding compound is 5 to 15 weight %.

CLAIMS

1. A phenolic resin molding compound comprising:

(A) a novolac phenolic resin with an o/p ratio (ortho/para ratio) of 0.7 to 0.9;

(B) a novolac phenolic resin with an o/p ratio of 1.1 to 1.3;

(C) talc; and

(D) a polyethylene or polyethylene/polypropylene copolymer, wherein

an amount of (D) the polyethylene or polyethylene/polypropylene copolymer relative to a total weight of the phenolic resin molding compound is 0.5 to 1.5 weight %, the weight ratio between the novolac phenolic resin (A) and the novolac phenolic resin (B), which is (B)/(A) is in the range of 0.5 to 1, the total amount of (A) and (B) relative to the total amount of the phenolic resin molding compound is 20 to 40 weight %, and an amount of (C) relative to the total amount of the phenolic resin molding compound is 7 to 12 weight %.